

August 2014

FQA28N50

N-Channel QFET[®] MOSFET 500 V, 28.4 A, 160 m Ω

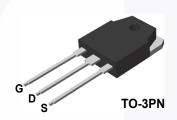
Features

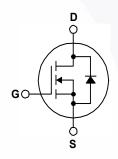
- 28.4 A, 500 V, $R_{DS(on)}$ = 160 m Ω (Max.) @ V_{GS} = 10 V, I_D = 14.2 A
- Low Gate Charge (Typ. 110 nC)
- Low Crss (Typ. 60 pF)
- · 100% Avalanche Tested
- RoHS compliant

Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switch mode power supply, power factor correction, electronic lamp ballast based on half bridge.





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

| Symbol | Parameter | | FQA28N50 | Unit |
|-----------------------------------|--|----------|-------------|------|
| V _{DSS} | Drain-Source Voltage | | 500 | V |
| I _D | Drain Current - Continuous (T _C = 25°C) | | 28.4 | Α |
| | - Continuous (T _C = 100°C) | | 18 | Α |
| I _{DM} | Drain Current - Pulsed | (Note 1) | 113.6 | Α |
| V _{GSS} | Gate-Source Voltage | | ± 30 | V |
| E _{AS} | Single Pulsed Avalanche Energy | (Note 2) | 1300 | mJ |
| I _{AR} | Avalanche Current | (Note 1) | 28.4 | Α |
| E _{AR} | Repetitive Avalanche Energy | (Note 1) | 31 | mJ |
| dv/dt | Peak Diode Recovery dv/dt | (Note 3) | 4.5 | V/ns |
| P_{D} | Power Dissipation (T _C = 25°C) | | 310 | W |
| | - Derate above 25°C | | 2.5 | W/°C |
| T _J , T _{STG} | Operating and Storage Temperature Range | | -55 to +150 | °C |
| T _L | Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds | | 300 | °C |

Thermal Characteristics

| Symbol | Parameter | Тур. | Max. | Unit |
|-----------------|---|------|------|------|
| $R_{\theta JC}$ | Thermal Resistance, Junction-to-Case | | 0.4 | °C/W |
| $R_{\theta CS}$ | Thermal Resistance, Case-to-Sink | 0.24 | | °C/W |
| $R_{\theta JA}$ | Thermal Resistance, Junction-to-Ambient | | 40 | °C/W |

Package Marking and Ordering Information

Parameter

| Part Number | Top Mark | Package | Packing Method | Reel Size | Tape Width | Quantity |
|-------------|----------|---------|----------------|-----------|------------|----------|
| FQA28N50 | FQA28N50 | TO-3PN | Tube | N/A | N/A | 30 units |

Min.

Тур.

28

Max.

Unit

S

Electrical Characteristics $T_C = 25^{\circ}C$ unless otherwise noted.

| | racteristics | | | | | |
|-----------------------------------|---|---|-----|-------|------|------|
| BV_{DSS} | Drain-Source Breakdown Voltage | $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$ | 500 | | | V |
| $\Delta BV_{DSS}/$ ΔT_{J} | Breakdown Voltage Temperature Coefficient | I _D = 250 μA, Referenced to 25°C | | 0.5 | | V/°C |
| I _{DSS} | | V _{DS} = 500 V, V _{GS} = 0 V | | | 1 | μА |
| Zero | Zero Gate Voltage Drain Current | V _{DS} = 400 V, T _C = 125°C | | | 10 | μА |
| I _{GSSF} | Gate-Body Leakage Current, Forward | V _{GS} = 30 V, V _{DS} = 0 V | | | 100 | nA |
| I _{GSSR} | Gate-Body Leakage Current, Reverse | $V_{GS} = -30 \text{ V}, V_{DS} = 0 \text{ V}$ | | | -100 | nA |
| On Cha | racteristics | | | | | |
| V _{GS(th)} | Gate Threshold Voltage | $V_{DS} = V_{GS}, I_{D} = 250 \mu A$ | 3.0 | | 5.0 | V |
| R _{DS(on)} | Static Drain-Source On-Resistance | V _{GS} = 10 V, I _D = 14.2 A | | 0.126 | 0.16 | Ω |

Dynamic Characteristics

Forward Transconductance

Symbol

g_{FS}

| C _{iss} | Input Capacitance | V _{DS} = 25 V, V _{GS} = 0 V, | 4300 | 5600 | pF |
|------------------|------------------------------|--|----------|------|----|
| C _{oss} | Output Capacitance | f = 1.0 MHz | 640 | 830 | pF |
| C _{rss} | Reverse Transfer Capacitance | | 60 | 80 | pF |

 $V_{DS} = 50 \text{ V}, I_{D} = 14.2 \text{ A}$

Switching Characteristics

| t _{d(on)} | Turn-On Delay Time | V _{DD} = 250 V, I _D = 28.4 A, | | 100 | 210 | ns |
|--------------------|---------------------|---|--|-----|-----|----|
| t _r | Turn-On Rise Time | $R_G = 25 \Omega$ | | 290 | 590 | ns |
| $t_{d(off)}$ | Turn-Off Delay Time | S | | 250 | 510 | ns |
| t _f | Turn-Off Fall Time | (Note 4) | | 175 | 360 | ns |
| Q_g | Total Gate Charge | V _{DS} = 400 V, I _D = 28.4 A, | | 110 | 140 | nC |
| Q_{gs} | Gate-Source Charge | V _{GS} = 10 V | | 26 | | nC |
| Q _{gd} | Gate-Drain Charge | (Note 4) | | 52 | | nC |

Drain-Source Diode Characteristics and Maximum Ratings

| Is | Maximum Continuous Drain-Source Diode Forward Current | | | | 28.4 | Α |
|-----------------|---|---------------------------------|--|-----|-------|----|
| I _{SM} | Maximum Pulsed Drain-Source Diode Forward Current | | | | 113.6 | Α |
| V _{SD} | Drain-Source Diode Forward Voltage V _{GS} = 0 V, I _S = 28.4 A | | | | 1.4 | V |
| t _{rr} | Reverse Recovery Time $V_{GS} = 0 \text{ V, I}_{S} = 28.4 \text{ A},$ | | | 440 | | ns |
| Q _{rr} | Reverse Recovery Charge | dI _F / dt = 100 A/μs | | 5.7 | | μС |

Notes

^{1.} Repetitive rating : pulse width limited by maximum junction temperature.

^{2.} L = 2.9 mH, I_{AS} = 28.4 A, V_{DD} = 50 V, R_{G} = 25 Ω , starting T_{J} = 25°C.

^{3.} $I_{SD} \le 28.4$ A, di/dt ≤ 200 A/ μ s, $V_{DD} \le BV_{DSS}$, starting T_J = 25°C.

^{4.} Essentially independent of operating temperature.

Typical Characteristics

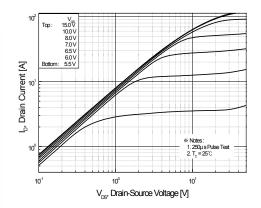


Figure 1. On-Region Characteristics

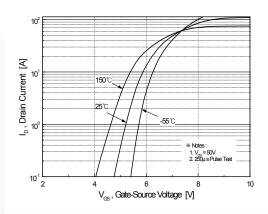


Figure 2. Transfer Characteristics

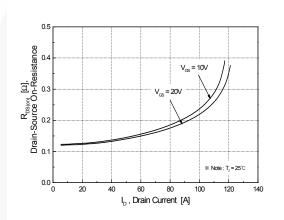


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

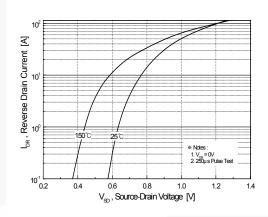


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

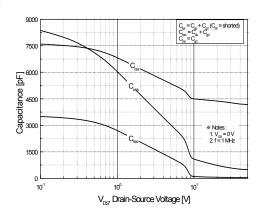


Figure 5. Capacitance Characteristics

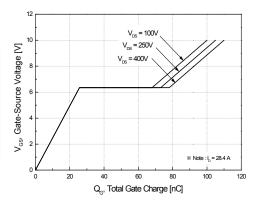
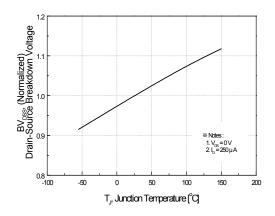


Figure 6. Gate Charge Characteristics

Typical Characteristics (Continued)



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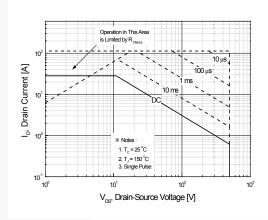
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Figure 7. Breakdown Voltage Variation vs. Temperature





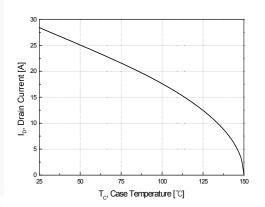


Figure 9. Maximum Safe Operating Area

Figure 10. Maximum Drain Current vs. Case Temperature

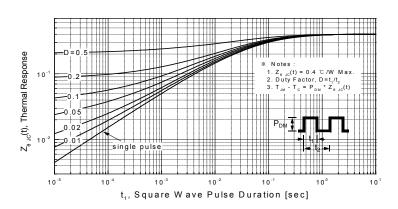


Figure 11. Transient Thermal Response Curve

Figure 12. Gate Charge Test Circuit & Waveform

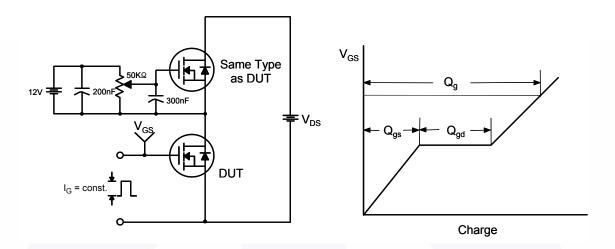


Figure 13. Resistive Switching Test Circuit & Waveforms

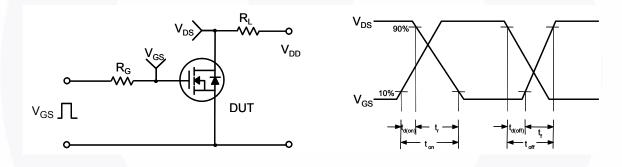
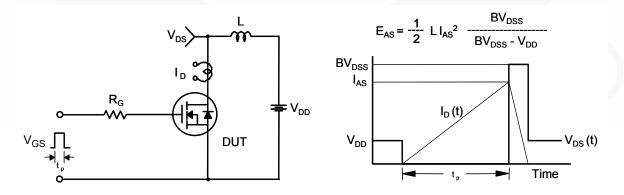


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms



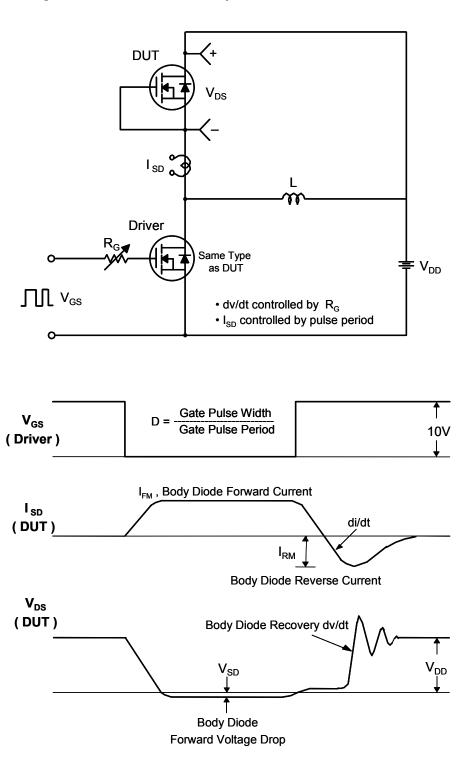
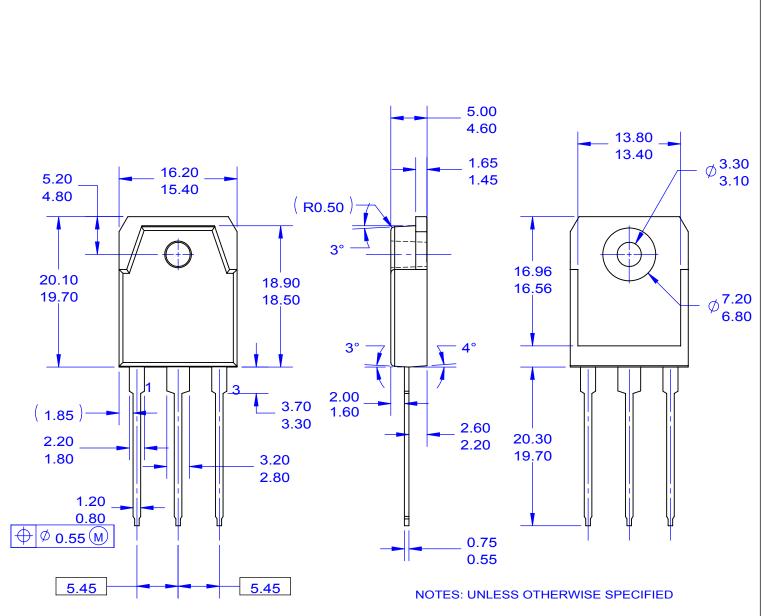
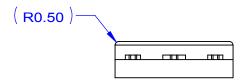


Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms





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- D) DIMENSIONS ARE EXCLUSSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSSIONS.
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- F) FAIRCHILD SEMICONDUCTOR.







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| Definition of Terms | | | | | | |
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